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## What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

## Applications of "[Embedded - Microcontrollers](#)"

### Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	12MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	14
Program Memory Size	2KB (2K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	125 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	<a href="https://www.e-xfl.com/product-detail/zilog/z86e0812hsc1903tr">https://www.e-xfl.com/product-detail/zilog/z86e0812hsc1903tr</a>

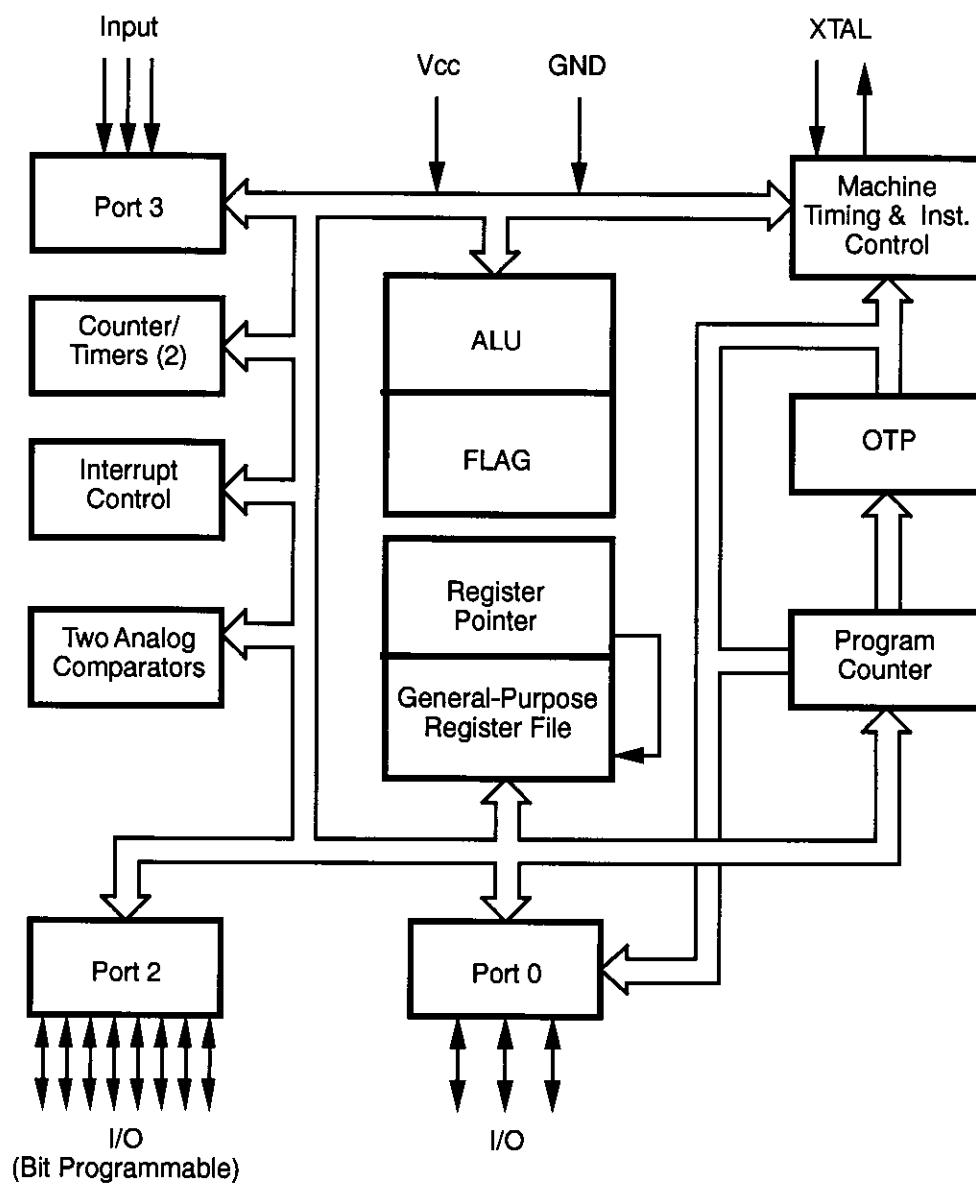


Figure 1. Functional Block Diagram

# GENERAL DESCRIPTION (Continued)

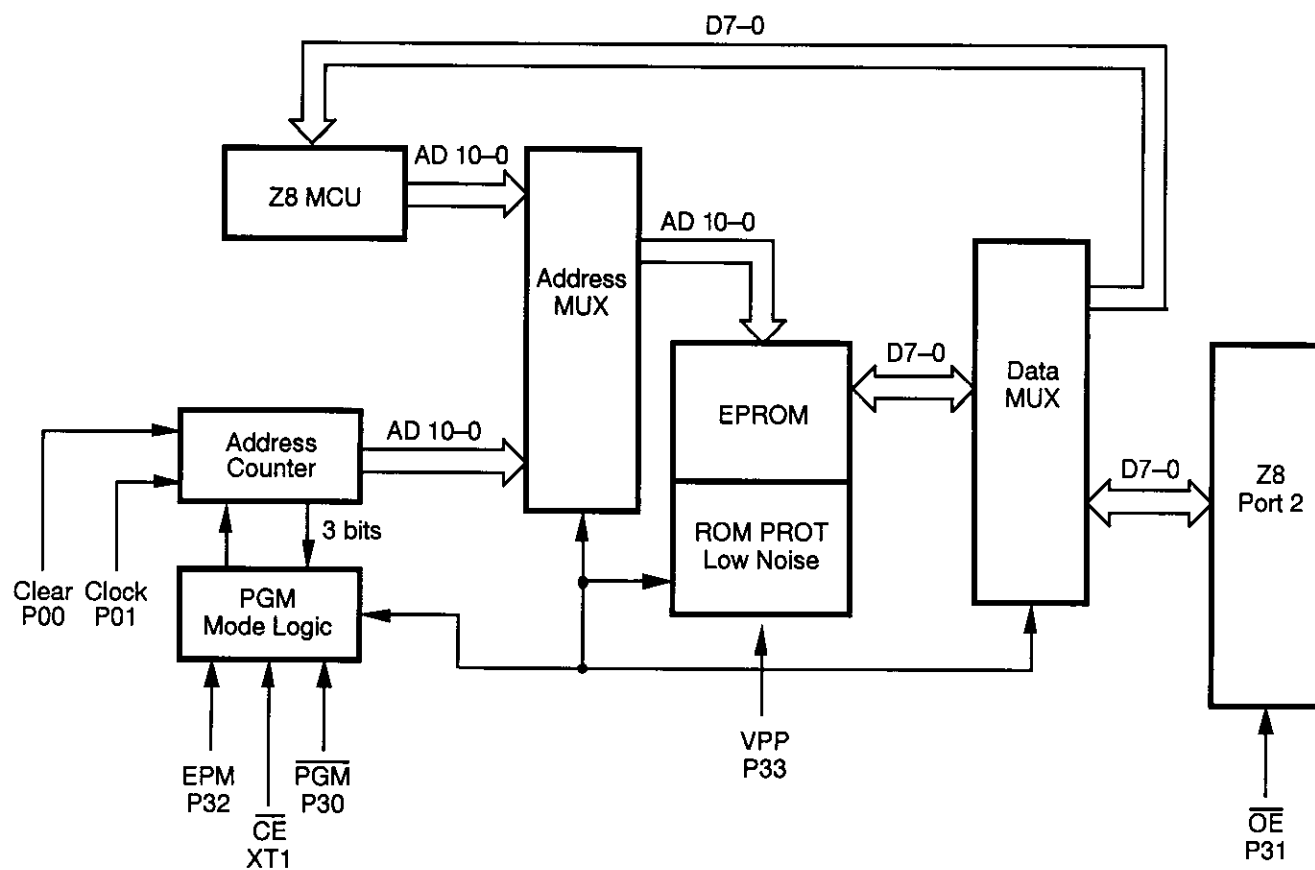


Figure 2. EPROM Programming Mode Block Diagram

## PIN DESCRIPTION

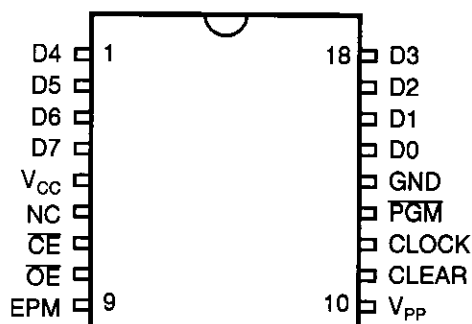


Figure 3. 18-Pin EPROM Mode Configuration

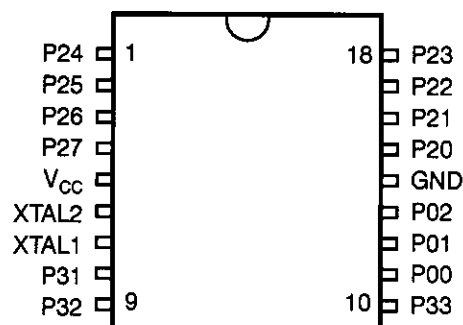


Figure 4. 18-Pin DIP/SOIC Mode Configuration

Table 1. 18-Pin DIP Pin Identification

EPROM Programming Mode			
Pin #	Symbol	Function	Direction
1–4	D4–D7	Data 4, 5, 6, 7	In/Output
5	V <sub>CC</sub>	Power Supply	
6	NC	No Connection	
7	CE	Chip Enable	Input
8	OE	Output Enable	Input
9	EPM	EPROM Prog Mode	Input
10	V <sub>PP</sub>	Prog Voltage	Input
11	Clear	Clear Clock	Input
12	Clock	Address	Input
13	PGM	Prog Mode	Input
14	GND	Ground	
15–18	D0–D3	Data 0,1, 2, 3	In/Output

Table 2. 18-Pin DIP/SOIC Pin Identification

Standard Mode			
Pin #	Symbol	Function	Direction
1–4	P24–P27	Port 2, Pins 4,5,6,7	In/Output
5	V <sub>CC</sub>	Power Supply	
6	XTAL2	Crystal Osc. Clock	Output
7	XTAL1	Crystal Osc. Clock	Input
8	P31	Port 3, Pin 1, AN1	Input
9	P32	Port 3, Pin 2, AN2	Input
10	P33	Port 3, Pin 3, REF	Input
11–13	P00–P02	Port 0, Pins 0,1,2	In/Output
14	GND	Ground	
15–18	P20–P23	Port 2, Pins 0,1,2,3	In/Output

**DC ELECTRICAL CHARACTERISTICS**

Standard Temperature

Sym	Parameter	$V_{CC}$ [4]	$T_A = 0^\circ\text{C to } +70^\circ\text{C}$		Typical @ $25^\circ\text{C}$	Units	Conditions	Notes
			Min	Max				
$V_{INMAX}$	Max Input Voltage	4.5V		12		V	$I_{in} < 250 \mu\text{A}$	1
		5.5V		12		V	$I_{in} < 250 \mu\text{A}$	1
$V_{CH}$	Clock Input High Voltage	4.5V	$0.8 V_{CC}$	$V_{CC}+0.3$	2.8	V	Driven by External Clock Generator	
		5.5V	$0.8 V_{CC}$	$V_{CC}+0.3$	2.8	V	Driven by External Clock Generator	
$V_{CL}$	Clock Input Low Voltage	4.5V	$V_{SS}-0.3$	$0.2 V_{CC}$	1.7	V	Driven by External Clock Generator	
		5.5V	$V_{SS}-0.3$	$0.2 V_{CC}$	1.7	V	Driven by External Clock Generator	
$V_{IH}$	Input High Voltage	4.5V	$0.7 V_{CC}$	$V_{CC}+0.3$	2.8	V		
		5.5V	$0.7 V_{CC}$	$V_{CC}+0.3$	2.8	V		
$V_{IL}$	Input Low Voltage	4.5V	$V_{SS}-0.3$	$0.2 V_{CC}$	1.5	V		
		5.5V	$V_{SS}-0.3$	$0.2 V_{CC}$	1.5	V		
$V_{OH}$	Output High Voltage	4.5V	$V_{CC}-0.4$		4.8	V	$I_{OH} = -2.0 \text{ mA}$	5
		5.5V	$V_{CC}-0.4$		4.8	V	$I_{OH} = -2.0 \text{ mA}$	5
		4.5V	$V_{CC}-0.4$		4.8	V	Low Noise @ $I_{OH} = -0.5 \text{ mA}$	
		5.5V	$V_{CC}-0.4$		4.8	V	Low Noise @ $I_{OH} = -0.5 \text{ mA}$	
$V_{OL1}$	Output Low Voltage	4.5V		0.8	0.1	V	$I_{OL} = +4.0 \text{ mA}$	5
		5.5V		0.4	0.1	V	$I_{OL} = +4.0 \text{ mA}$	5
		4.5V		0.4	0.1	V	Low Noise @ $I_{OL} = 1.0 \text{ mA}$	
		5.5V		0.4	0.1	V	Low Noise @ $I_{OL} = 1.0 \text{ mA}$	
$V_{OL2}$	Output Low Voltage	4.5V		0.8	0.8	V	$I_{OL} = +12 \text{ mA}$ ,	5
		5.5V		0.8	0.8	V	$I_{OL} = +12 \text{ mA}$ ,	5
$V_{OFFSET}$	Comparator Input Offset Voltage	4.5V		25.0	10.0	mV		
		5.5V		25.0	10.0	mV		
$V_{LV}$	$V_{CC}$ Low Voltage Auto Reset		2.2	3.0	2.8	V	@ 6 MHz Max. Int. CLK Freq.	
$I_{IL}$	Input Leakage (Input Bias Current of Comparator)	4.5V	-1.0	1.0		$\mu\text{A}$	$V_{IN} = 0\text{V}, V_{CC}$	
		5.5V	-1.0	1.0		$\mu\text{A}$	$V_{IN} = 0\text{V}, V_{CC}$	
$I_{OL}$	Output Leakage	4.5V	-1.0	1.0		$\mu\text{A}$	$V_{IN} = 0\text{V}, V_{CC}$	
		5.5V	-1.0	1.0		$\mu\text{A}$	$V_{IN} = 0\text{V}, V_{CC}$	
$V_{ICR}$	Comparator Input Common Mode Voltage Range		0	$V_{CC}-1.0$		V		

## DC ELECTRICAL CHARACTERISTICS (Continued)

Sym	Parameter	V <sub>CC</sub> [4]	T <sub>A</sub> = 0°C to +70°C		Typical @ 25°C	Units	Conditions	Notes
			Min	Max				
I <sub>CC1</sub>	Standby Current (Low Noise Mode)	4.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		5.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		4.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		5.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		4.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
		5.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
I <sub>CC2</sub>	Standby Current	4.5V		10.0	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
		5.5V		10.0	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
I <sub>ALL</sub>	Auto Latch Low Current	4.5V		32.0	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		32.0	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
I <sub>ALH</sub>	Auto Latch High Current	4.5V		-16.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		-16.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	

## Notes:

- Port 2 and Port 0 only
- V<sub>SS</sub> = 0V = GND
- The device operates down to V<sub>LV</sub> of the specified frequency for V<sub>LV</sub>. The minimum operational V<sub>CC</sub> is determined on the value of the voltage V<sub>LV</sub> at the ambient temperature. The V<sub>LV</sub> increases as the temperature decreases.
- V<sub>CC</sub> = 4.5 to 5.5V, typical values measured at V<sub>CC</sub> = 5.0V.  
The V<sub>CC</sub> voltage specification of 5.5 V guarantees 5.0 V ± 0.5V with typical values measured at V<sub>CC</sub> = 5.0V.
- Standard Mode (not Low EMI Mode)
- Z86E08 only
- All outputs unloaded and all inputs are at V<sub>CC</sub> or V<sub>SS</sub> level.
- If analog comparator is selected, then the comparator inputs must be at V<sub>CC</sub> level.

Sym	Parameter	V <sub>CC</sub> [4]	T <sub>A</sub> = -40°C to +105°C		Typical @ 25°C	Units	Conditions	Notes
			Min	Max				
I <sub>CC1</sub>	Standby Current (Low Noise Mode)	4.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		5.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		4.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		5.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		4.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
		5.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
I <sub>CC2</sub>	Standby Current	4.5V		20	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
		5.5V		20	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
I <sub>ALL</sub>	Auto Latch Low Current	4.5V		40	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		40	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
I <sub>ALH</sub>	Auto Latch High Current	4.5V		-20.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		-20.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	

**Notes:**

1. Port 2 and Port 0 only
2. V<sub>SS</sub> = 0V = GND
3. The device operates down to V<sub>LV</sub> of the specified frequency for V<sub>LV</sub>. The minimum operational V<sub>CC</sub> is determined on the value of the voltage V<sub>LV</sub> at the ambient temperature. The V<sub>LV</sub> increases as the temperature decreases.
4. V<sub>CC</sub> = 4.5V to 5.5V, typical values measured at V<sub>CC</sub> = 5.0V
5. Standard Mode (not Low EMI Mode)
6. Z86E08 only
7. All outputs unloaded and all inputs are at V<sub>CC</sub> or V<sub>SS</sub> level.
8. If analog comparator is selected, then the comparator inputs must be at V<sub>CC</sub> level.

**AC ELECTRICAL CHARACTERISTICS**

Timing Table (Standard Mode for SCLK/TCLK = XTAL/2)

Standard Temperature

15		$T_A = 0\text{ }^{\circ}\text{C to } +70\text{ }^{\circ}\text{C}$							
No	Symbol	Parameter	$V_{CC}$	8 MHz		12 MHz		Units	Notes
				Min	Max	Min	Max		
1	TpC	Input Clock Period	4.5V	125	DC	83	DC	ns	1
			5.5V	125	DC	83	DC	ns	1
2	TrC,TfC	Clock Input Rise and Fall Times	4.5V		25		15	ns	1
			5.5V		25		15	ns	1
3	TwC	Input Clock Width	4.5V	62		41		ns	1
			5.5V	62		41		ns	1
4	TwTinL	Timer Input Low Width	4.5V	100		100		ns	1
			5.5V	70		70		ns	1
5	TwTinH	Timer Input High Width	4.5V	5TpC		5TpC			1
			5.5V	5TpC		5TpC			1
6	TpTin	Timer Input Period	4.5V		8TpC	8TpC			1
			5.5V		8TpC	8TpC			1
7	TrTin, TtTin	Timer Input Rise and Fall Time	4.5V		100		100	ns	1
			5.5V		100		100	ns	1
8	TwIL	Int. Request Input Low Time	4.5V	70		70		ns	1,2
			5.5V	70		70		ns	1,2
9	TwIH	Int. Request Input High Time	4.5V		5TpC	5TpC			1,2
			5.5V		5TpC	5TpC			1,2
10	Twdt	Watch-Dog Timer Delay Time for Timeout	4.5V	12		12		ms	1
			5.5V	12		12		ms	1
11	Tpor	Power-On Reset Time	4.5V	20	80	20	80	ms	1
			5.5V	20	80	20	80	ms	1

**Notes:**

1. Timing Reference uses 0.7  $V_{CC}$  for a logic 1 and 0.2  $V_{CC}$  for a logic 0.
2. Interrupt request through Port 3 (P33–P31).



# AC ELECTRICAL CHARACTERISTICS

Timing Table (Standard Mode for SCLK/TCLK = XTAL/2)

Extended Temperature

No	Symbol	Parameter	V <sub>CC</sub>	T <sub>A</sub> = −40 °C to +105 °C				Units	Notes
				8 MHz		12 MHz			
1	TpC	Input Clock Period	4.5V	125	DC	83	DC	ns	1
			5.5V	125	DC	83	DC	ns	1
2	TrC,TfC	Clock Input Rise and Fall Times	4.5V		25		15	ns	1
			5.5V		25		15	ns	1
3	TwC	Input Clock Width	4.5V		62		41	ns	1
			5.5V		62		41	ns	1
4	TwTinL	Timer Input Low Width	4.5V	70		70		ns	1
			5.5V	70		70		ns	1
5	TwTinH	Timer Input High Width	4.5V	5TpC		5TpC			1
			5.5V	5TpC		5TpC			1
6	TpTin	Timer Input Period	4.5V	8TpC		8TpC			1
			5.5V	8TpC		8TpC			1
7	TrTin, TtTin	Timer Input Rise and Fall Time	4.5V		100		100	ns	1
			5.5V		100		100	ns	1
8	TwIL	Int. Request Input Low Time	4.5V	70		70		ns	1,2
			5.5V	70		70		ns	1,2
9	TwIH	Int. Request Input High Time	4.5V	5TpC		5TpC			1,2
			5.5V	5TpC		5TpC			1,2
10	Twdt	Watch-Dog Timer Delay Time for Timeout	4.5V	10		10		ms	1
			5.5V	10		10		ms	1
11	Tpor	Power-On Reset Time	4.5V	12	100	12	100	ms	1
			5.5V	12	100	12	100	ms	1

## Notes:

1. Timing Reference uses 0.7 V<sub>CC</sub> for a logic 1 and 0.2 V<sub>CC</sub> for a logic 0.
2. Interrupt request made through Port 3 (P33–P31).

## LOW NOISE VERSION

### Low EMI Emission

The Z86E04/E08 can be programmed to operate in a Low EMI Emission Mode by means of a mask ROM bit option. Use of this feature results in:

- All pre-driver slew rates reduced to 10 ns typical.
- Internal SCLK/TCLK operation limited to a maximum of 4 MHz–250 ns cycle time.

- Output drivers have resistances of 500 Ohms (typical).
- Oscillator divide-by-two circuitry eliminated.

The Low EMI Mode is mask-programmable to be selected by the customer at the time the ROM code is submitted.

## PIN FUNCTIONS

### OTP Programming Mode

**D7–D0 Data Bus.** Data can be read from, or written to, the EPROM through this data bus.

**V<sub>CC</sub> Power Supply.** It is typically 5V during EPROM Read Mode and 6.4V during the other modes (Program, Program Verify, and so on).

**$\overline{CE}$  Chip Enable (active Low).** This pin is active during EPROM Read Mode, Program Mode, and Program Verify Mode.

**$\overline{OE}$  Output Enable (active Low).** This pin drives the Data Bus direction. When this pin is Low, the Data Bus is output. When High, the Data Bus is input.

**EPM EPROM Program Mode.** This pin controls the different EPROM Program Modes by applying different voltages.

**V<sub>PP</sub> Program Voltage.** This pin supplies the program voltage.

**Clear Clear (active High).** This pin resets the internal address counter at the High Level.

**Clock Address Clock.** This pin is a clock input. The internal address counter increases by one with one clock cycle.

**PGM Program Mode (active Low).** A Low level at this pin programs the data to the EPROM through the Data Bus.

### Application Precaution

The production test-mode environment may be enabled accidentally during normal operation if **excessive noise** surges above V<sub>CC</sub> occur on the XTAL1 pin.

In addition, processor operation of Z8 OTP devices may be affected by **excessive noise** surges on the V<sub>PP</sub>,  $\overline{CE}$ , EPM,  $\overline{OE}$  pins while the microcontroller is in Standard Mode.

Recommendations for dampening voltage surges in both test and OTP Mode include the following:

- Using a clamping diode to V<sub>CC</sub>.
- Adding a capacitor to the affected pin.

**Note:** Programming the EPROM/Test Mode Disable option will prevent accidental entry into EPROM Mode or Test Mode.

## PIN FUNCTIONS (Continued)

**XTAL1, XTAL2** *Crystal In, Crystal Out* (time-based input and output, respectively). These pins connect a parallel-resonant crystal, LC, or an external single-phase clock (8 MHz or 12 MHz max) to the on-chip clock oscillator and buffer.

**Port 0, P02–P00.** Port 0 is a 3-bit bidirectional, Schmitt-triggered CMOS-compatible I/O port. These three I/O lines can be globally configured under software control to be inputs or outputs (Figure 7).

**Auto Latch.** The Auto Latch puts valid CMOS levels on all CMOS inputs (except P33, P32, P31) that are not externally driven. A valid CMOS level, rather than a floating node, reduces excessive supply current flow in the input buffer. On Power-up and Reset, the Auto Latch will set the ports to an undetermined state of 0 or 1. Default condition is Auto Latches enabled.

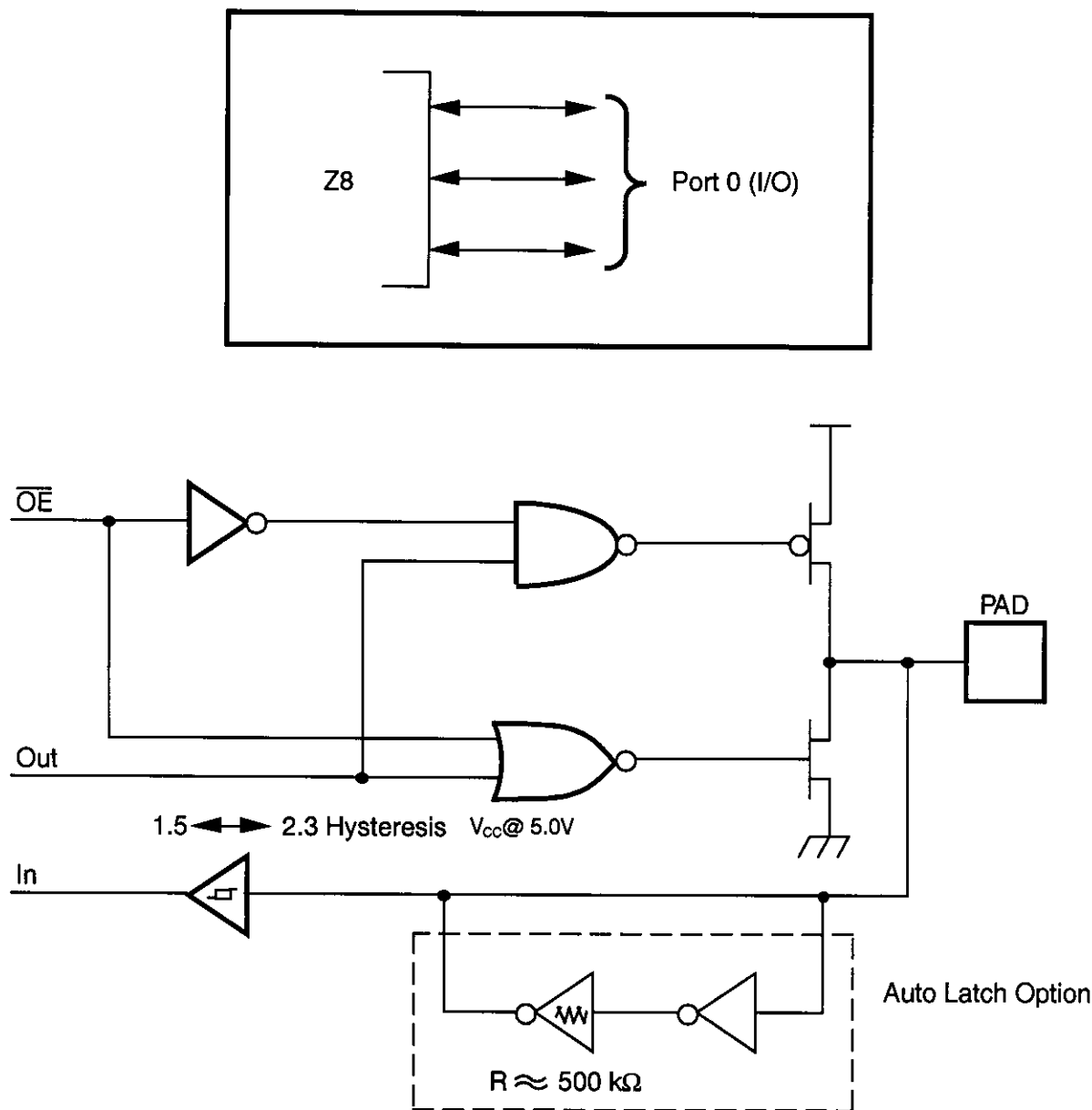
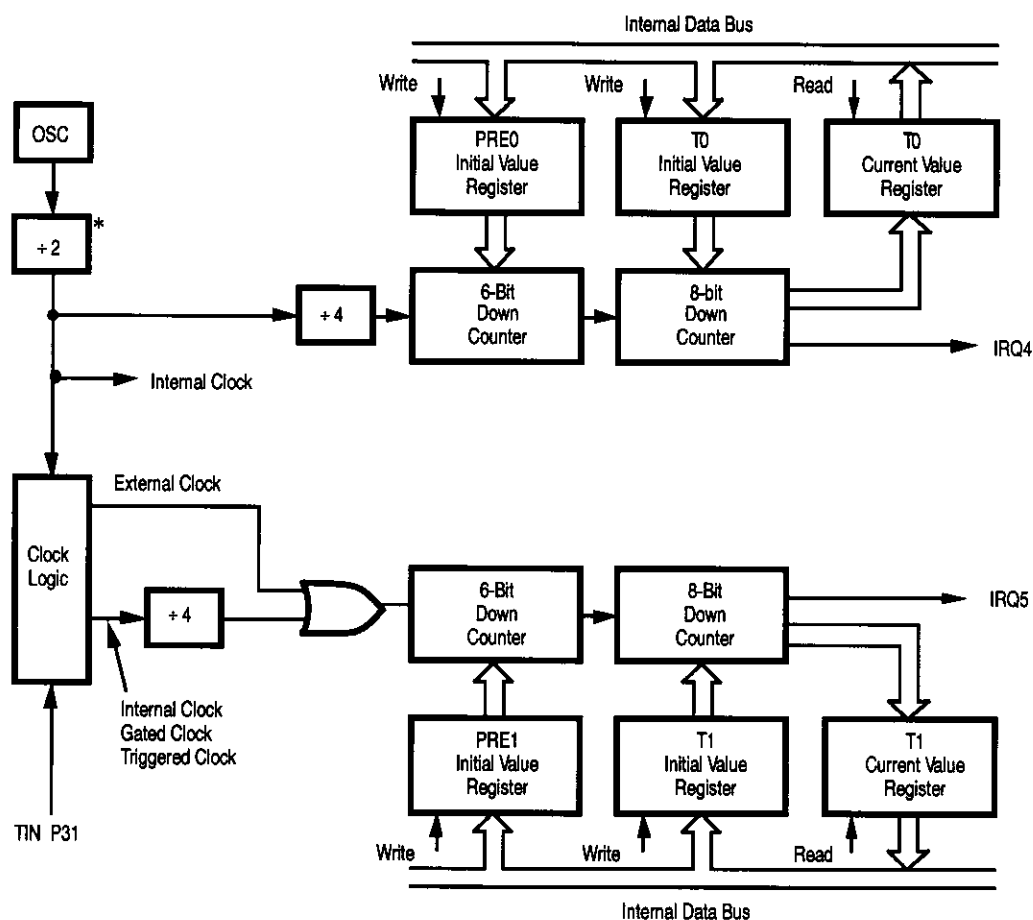


Figure 7. Port 0 Configuration



\* **Note:** By passed, if Low EMI Mode is selected.

**Figure 14. Counter/Timers Block Diagram**

## Low EMI Emission

The Z8 can be programmed to operate in a low EMI Emission (Low Noise) Mode by means of an EPROM programmable bit option. Use of this feature results in:

- Less than 1 mA consumed during HALT Mode.
- All drivers slew rates reduced to 10 ns (typical).
- Internal SCLK/TCLK = XTAL operation limited to a maximum of 4 MHz–250 ns cycle time.
- Output drivers have resistances of 500 ohms (typical).
- Oscillator divide-by-two circuitry eliminated.

In addition to  $V_{DD}$  and GND ( $V_{SS}$ ), the Z8 changes all its pin functions in the EPROM Mode. XTAL2 has no function, XTAL1 functions as  $\overline{CE}$ , P31 functions as  $\overline{OE}$ , P32 functions as EPM, P33 functions as  $V_{PP}$ , and P02 functions as PGM.

**ROM Protect.** ROM Protect fully protects the Z8 ROM code from being read externally. When ROM Protect is selected, the instructions LDC and LDCI are supported (Z86E04/E08 and Z86C04/C08 do not support the instructions of LDE and LDEI). When the device is programmed for ROM Protect, the Low Noise feature will not automatically be enabled.

Please note that when using the device in a noisy environment, it is suggested that the voltages on the EPM and  $\overline{CE}$  pins be clamped to  $V_{CC}$  through a diode to  $V_{CC}$  to prevent accidentally entering the OTP Mode. The  $V_{PP}$  requires both a diode and a 100 pF capacitor.

**Auto Latch Disable.** Auto Latch Disable option bit when programmed will globally disable all Auto Latches.

**WDT Enable.** The WDT Enable option bit, when programmed, will have the hardware enabled Permanent WDT enabled after exiting reset and can not be stopped in Halt or Stop Mode.

**EPROM/Test Mode Disable.** The EPROM/Test Mode Disable option bit, when programmed, will disable the EPROM Mode and the Factory Test Mode. Reading, verifying, and programming the Z8 will be disabled. To fully verify that this mode is disabled, the device must be power cycled.

**User Modes.** Table 7 shows the programming voltage of each mode.

Table 7. OTP Programming Table

Programming Modes	$V_{PP}$	EPM	$\overline{CE}$	$\overline{OE}$	PGM	ADDR	DATA	$V_{CC}^*$
EPROM READ	NU	$V_H$	$V_{IL}$	$V_{IL}$	$V_{IH}$	ADDR	Out	5.0V
PROGRAM	$V_H$	$V_{IH}$	$V_{IL}$	$V_{IH}$	$V_{IL}$	ADDR	In	6.4V
PROGRAM VERIFY	$V_H$	$V_{IH}$	$V_{IL}$	$V_{IL}$	$V_{IH}$	ADDR	Out	6.4V
EPROM PROTECT	$V_H$	$V_H$	$V_H$	$V_{IH}$	$V_{IL}$	NU	NU	6.4V
LOW NOISE SELECT	$V_H$	$V_{IH}$	$V_H$	$V_{IH}$	$V_{IL}$	NU	NU	6.4V
AUTO LATCH DISABLE	$V_H$	$V_{IH}$	$V_H$	$V_{IL}$	$V_{IL}$	NU	NU	6.4V
WDT ENABLE	$V_H$	$V_{IL}$	$V_H$	$V_{IH}$	$V_{IL}$	NU	NU	6.4V
EPROM/TEST MODE	$V_H$	$V_{IL}$	$V_H$	$V_{IL}$	$V_{IL}$	NU	NU	6.4V

### Notes:

1.  $V_H = 12.75V \pm 0.25 V_{DC}$ .
2.  $V_{IH}$  = As per specific Z8 DC specification.
3.  $V_{IL}$  = As per specific Z8 DC specification.
4. X = Not used, but must be set to  $V_H$  or  $V_{IH}$  level.
5. NU = Not used, but must be set to either  $V_{IH}$  or  $V_{IL}$  level.
6.  $I_{PP}$  during programming = 40 mA maximum.
7.  $I_{CC}$  during programming, verify, or read = 40 mA maximum.
8. \*  $V_{CC}$  has a tolerance of  $\pm 0.25V$ .

**FUNCTIONAL DESCRIPTION (Continued)**

**Internal Address Counter.** The address of Z8 is generated internally with a counter clocked through pin P01 (Clock). Each clock signal increases the address by one and the "high" level of pin P00 (Clear) will reset the address to zero. Figure 18 shows the setup time of the serial address input.

**Programming Waveform.** Figures 19, 20, 21 and 22 show the programming waveforms of each mode. Table 8 shows the timing of programming waveforms.

**Programming Algorithm.** Figure 23 shows the flow chart of the Z8 programming algorithm.

**Table 8. Timing of Programming Waveforms**

Parameters	Name	Min	Max	Units
1	Address Setup Time	2		$\mu$ s
2	Data Setup Time	2		$\mu$ s
3	V <sub>pp</sub> Setup	2		$\mu$ s
4	V <sub>cc</sub> Setup Time	2		$\mu$ s
5	Chip Enable Setup Time	2		$\mu$ s
6	Program Pulse Width	0.95		ms
7	Data Hold Time	2		$\mu$ s
8	OE Setup Time	2		$\mu$ s
9	Data Access Time	188		ns
10	Data Output Float Time		100	ns
11	Overprogram Pulse Width	2.85		ms
12	EPM Setup Time	2		$\mu$ s
13	PGM Setup Time	2		$\mu$ s
14	Address to OE Setup Time	2		$\mu$ s
15	Option Program Pulse Width	78		ms
16	OE Width	250		ns
17	Address Valid to OE Low	125		ns

# FUNCTIONAL DESCRIPTION (Continued)

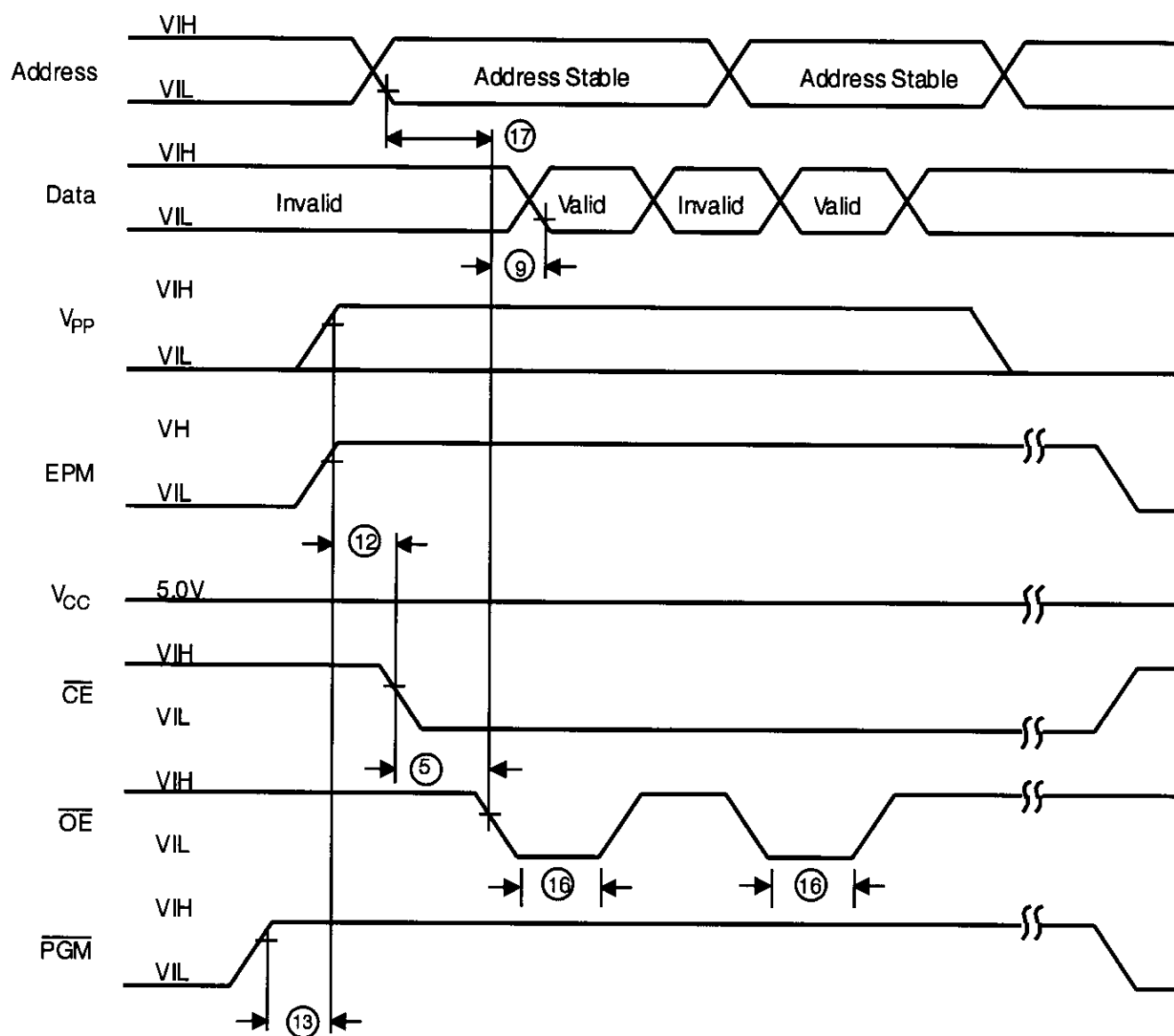


Figure 19. Z86E04/E08 Programming Waveform  
(EPROM Read)

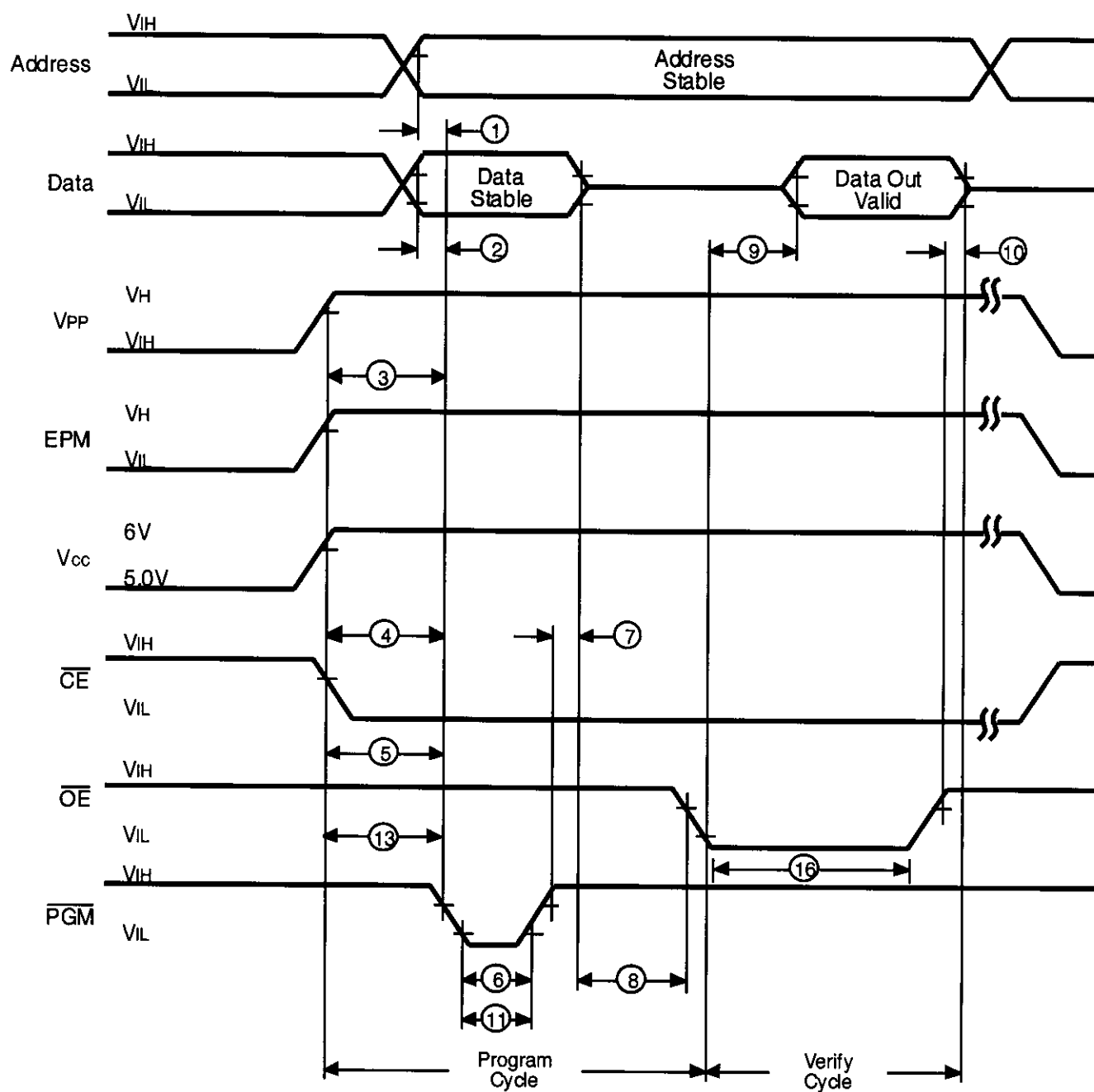


Figure 20. Z86E04/E08 Programming Waveform  
(Program and Verify)



# FUNCTIONAL DESCRIPTION (Continued)

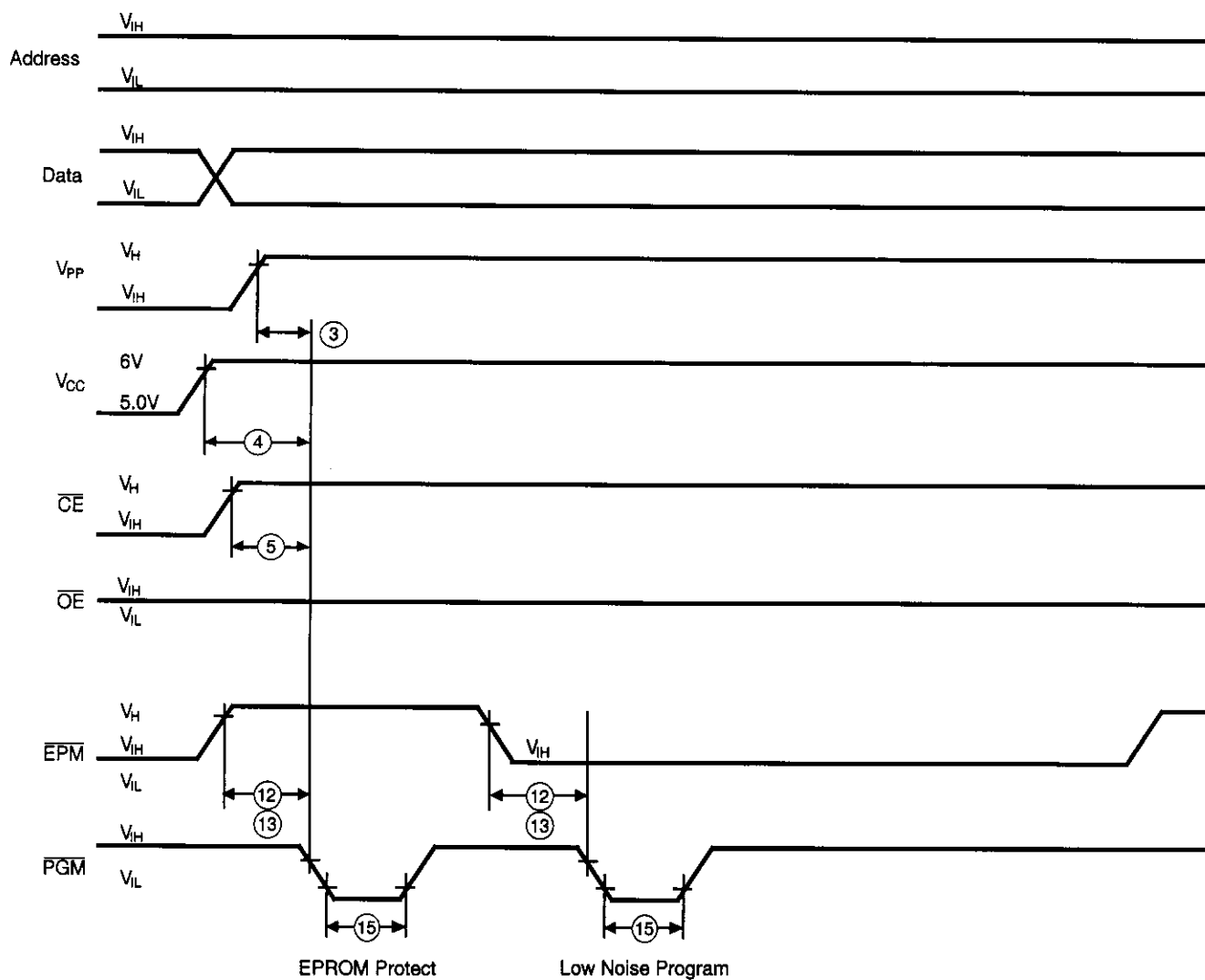
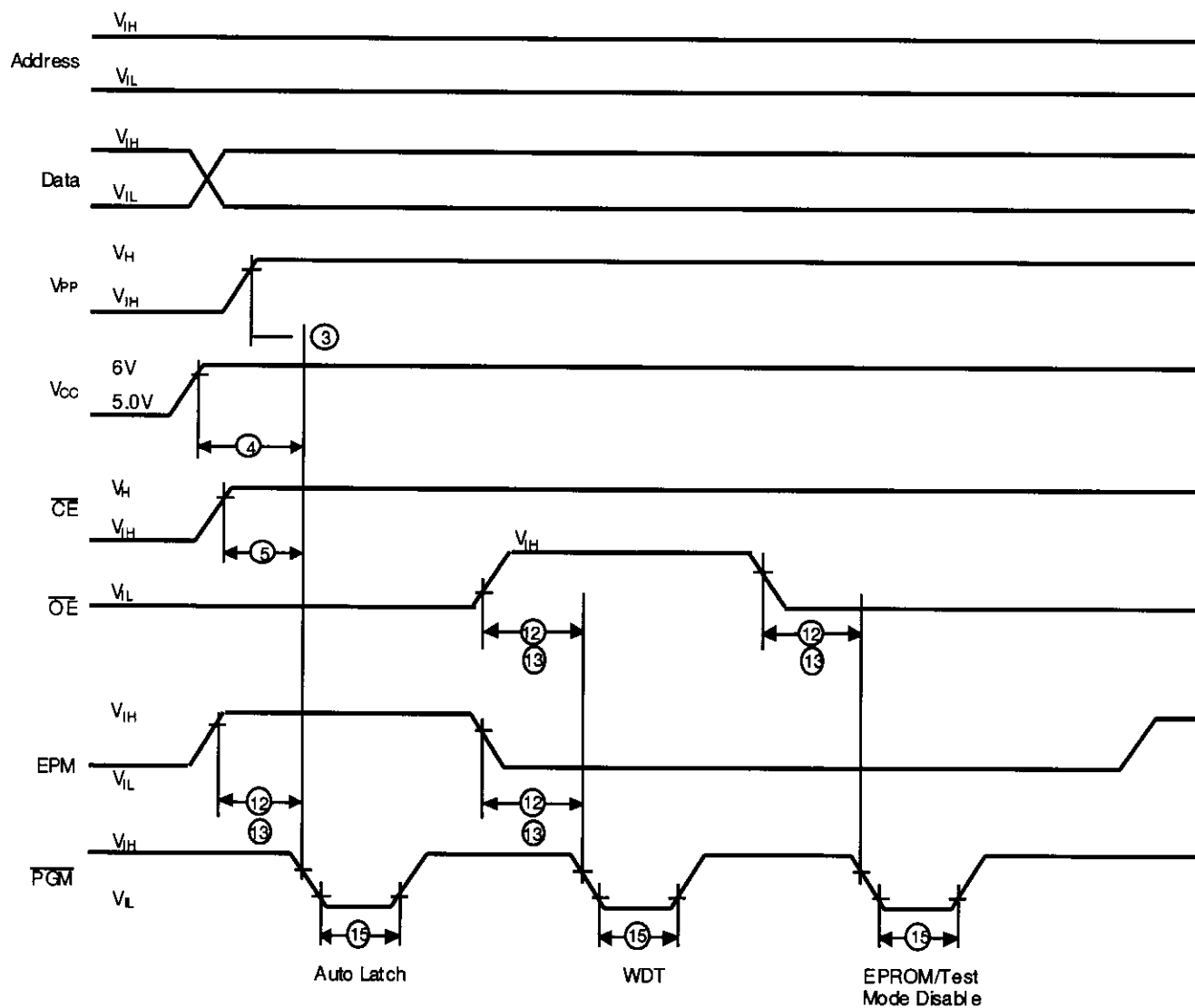


Figure 21. Z86E04/E08 Programming Options Waveform  
(EPROM Protect and Low Noise Program)



**Figure 22. Z86E04/E08 Programming Options Waveform  
(Auto Latch Disable, Permanent WDT Enable and  
EPROM/Test Mode Disable)**

## Z8 CONTROL REGISTERS (Continued)

R248 P01M

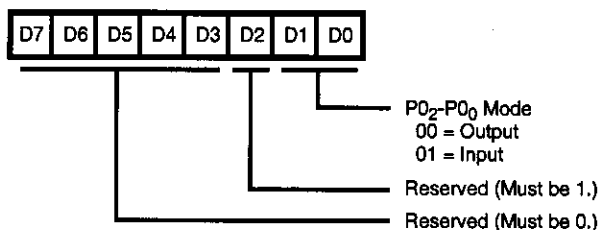


Figure 31. Port 0 and 1 Mode Register  
(F8<sub>H</sub>: Write Only)

R249 IPR

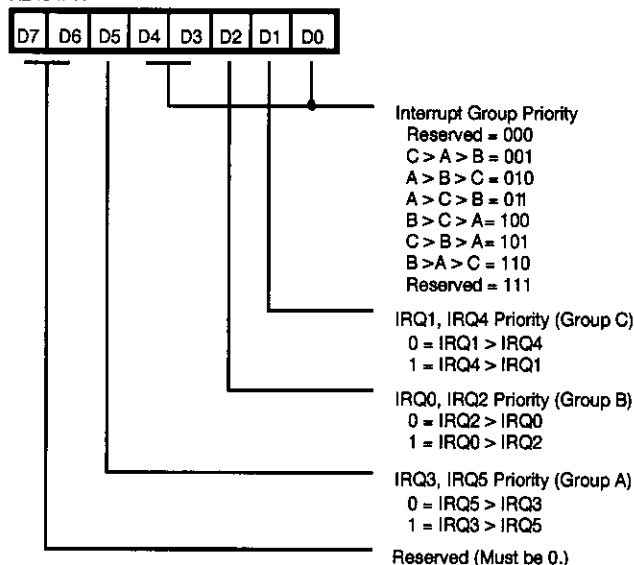


Figure 32. Interrupt Priority Register  
(F9<sub>H</sub>: Write Only)

R250 IRQ

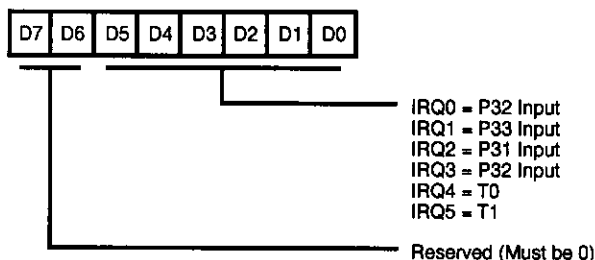


Figure 33. Interrupt Request Register  
(FA<sub>H</sub>: Read/Write)

R251 IMR

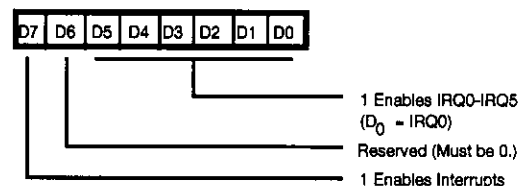


Figure 34. Interrupt Mask Register  
(FB<sub>H</sub>: Read/Write)

R252 Flags

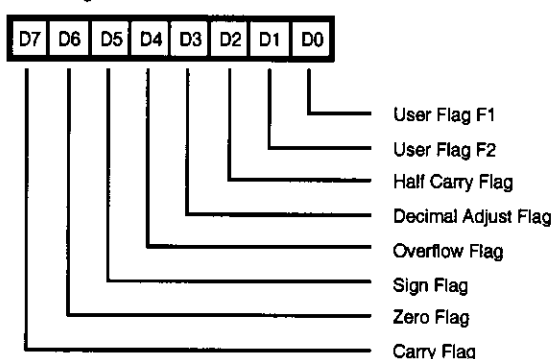


Figure 35. Flag Register  
(FC<sub>H</sub>: Read/Write)

R253 RP

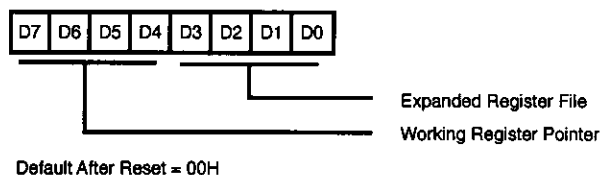


Figure 36. Register Pointer  
(FD<sub>H</sub>: Read/Write)

R255 SPL

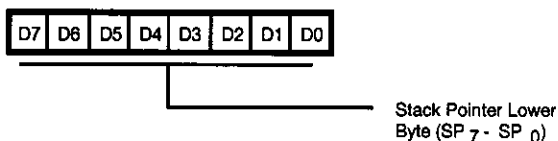


Figure 37. Stack Pointer  
(FF<sub>H</sub>: Read/Write)

## ORDERING INFORMATION

### Z86E04

#### Standard Temperature

18-Pin DIP	18-Pin SOIC
Z86E0412PSC	Z86E0412SSC
Z86E0412PEC	Z86E0412SEC

### Z86E08

#### Standard Temperature

18-Pin DIP	18-Pin SOIC
Z86E0812PSC	Z86E0812SSC
Z86E0812PEC	Z86E0812SEC

For fast results, contact your local Zilog sales office for assistance in ordering the part(s) desired.

## Codes

### Preferred Package

P = Plastic DIP

### Speeds

12 = 12 MHz

### Longer Lead Time

S = SOIC

### Environmental

C = Plastic Standard

### Preferred Temperature

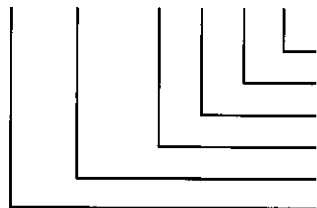
S = 0°C to +70°C

E = -40°C to +105°C

### Example:

**Z 86E04 12 P S C**

is a Z86E04, 12 MHz, DIP, 0°C to +70°C, Plastic Standard Flow



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**Pre-Characterization Product:**

The product represented by this CPS is newly introduced and Zilog has not completed the full characterization of the product. The CPS states what Zilog knows about this product at this time, but additional features or nonconformance with some aspects of the CPS may be

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